



Product Change Notification

112106 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112106 - 00
Change Title: Intel® Server System P4308IP4LHKC and Intel® Workstation System P4304CR2LFJN PCN 112106-00, Product Design, Documentation
Update ROC Module Printed Board Assembly, COM Cable Length and Quick Reference Guide Version
Date of Publication: March 15, 2013

Key Characteristics of the Change:
Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	March 30, 2013
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Description of Change to the Customer:

Intel will implement the following changes on Intel® Server System P4304CR2LFJN:

1. The COM cable length is changed from 290mm in length to 390mm in length.

Intel will implement the following changes on Intel® Server System P4308IP4LHKC:

1. The ROC module Printed Board Assembly (PBA) version is updated from G35316-601 to G35316-610. The ROC module is being updated with D1 Stepping chipset from C1 Stepping. This change allows for PCI Express* 3.0 functionality. In addition, the RAID module firmware will be updated to 23.9.0-0018 to support the D1 stepping chipset. Please refer to PCN111661-01 for detailed information.
2. The Quick Reference Guide is updated from G46033-003 to G46033-004

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers; no action is recommended or required. Previous versions of the RAID Module firmware will not function with the ROC Module with D1 Stepping chipset.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
P4304CR2LFJN	916047	G52397-001	G15585-401	G52397-001	G15585-401
P4308IP4LHKC	916063	G58675-001	G15585-401	G58675-001	G15585-401

PCN Revision History:**Date of Revision:**

March 15, 2013

Revision Number:

00

Reason:

Originally Published PCN